IN THE SPECIFICATION:

The paragraph beginning at the bottom of page 11 is presented in re-written "clean" format.

The active material feedstock may comprise a microstructured or nanostructured material, which after thermal spray results in electrodes with microstructured or nanostructured active material. As used herein "microstructructed" materials refers to materials having a grain size on the order of about 0.1 to about 500 micrometers (microns) and "nanostructured" materials refers to materials having a grain size on the order of 1 to 100 nanometers (where 1 nm = 10 angstroms). Nanostructured materials are thus characterized by having a high fraction of the materials' atoms residing at grain or particle boundaries. For example, with a grain size in the five nanometer range, about one-half of the atoms in a nanocrystalline or a nanophase solid reside at grain or particle interfaces. Rapid interaction between the active materials and its surroundings are possible because of high surface area of the nanostructured materials. Therefore, the materials could sustain high current charging and discharging conditions. Thermal spray of nanostructured feedstocks to produce nanostructured coatings is disclosed in U.S. Patent No. 6,025,034, filed February 5, 1998, entitled "Nanostructured Feeds for Thermal Spray Systems, Method of Manufacture, and Coatings Formed Therefrom," which is a continuation of U.S. patent application Serial No. 08/558,133 filed November 13, 1995, now abandoned, which is incorporated herein by reference.

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